

1. Description

The UMW IR2110STR is a high voltage, high speed power MOSFET drivers with dependent high and low-side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET in the high-side configuration which operates up to 600V.

3. Features

- Floating channel designed for bootstrap operation
- Fully operational to +600V
- 3.3V, 5V and 15V input logic compatible
- Tolerant to negative transient voltage dV/dt immune
- Allowable negative V_s capability: -9V
- Gate drive supply range from 10V to 20V
- Separate logic supply range from 3.3V to 20V
- Logic and power ground $\pm 5V$ offset

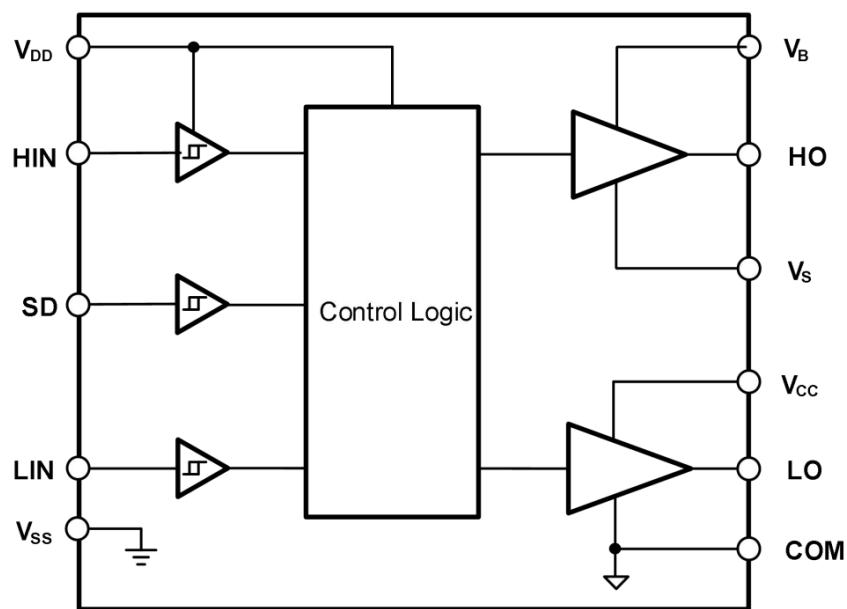
2. Application

- UPS Universal inverter
- Half-bridge and full-bridge converters in AC and DC power supplies
- High-density switching power supplies for servers, telecommunications, IT and industrial infrastructure
- Solar inverter and motor driver

- Undervoltage lockout for both channels
- Cycle by cycle edge-triggered shutdown logic
- Matched propagation delay for both channels
- Wide operating temperature range -40°C ~125°C
- Typically output Source/Sink current capability: 4A/4A

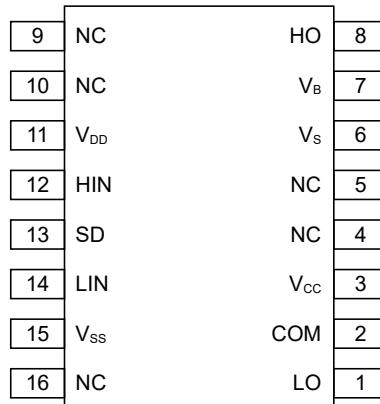


4. Functional Block Diagram





5. Pinning Information



SOP-16-300mil

Table6-1 Lead Definitions

Number	Symbol	Description
1	LO	Low side gate drive output
2	COM	Low side return
3	V _{cc}	Low side supply
6	V _s	High side floating supply return
7	V _B	High side floating supply
8	HO	High side gate drive output
11	V _{DD}	Logic supply
12	HIN	Logic input for high side gate driver output (HO), in phase
13	SD	Logic input for shutdown
14	LIN	Logic input for low side gate driver output (LO), in phase
15	V _{ss}	Logic ground



6. Absolute Maximum Ratings

Exceeding the limit maximum rating may cause permanent damage to the device. All voltage parameters are rated with reference to V_{SS} and an ambient temperature of 25°C.

Parameter	Symbol	Min	Max	Units
High side floating supply	V_B	-0.3	625	V
High side floating supply return	V_S	V_B-25	$V_B+0.3$	V
High side gate drive output	V_{HO}	$V_S-0.3$	$V_B+0.3$	V
Low side and main power supply	V_{CC}	-0.3	25	V
Low side gate drive output	V_{LO}	-0.3	$V_{CC}+0.3$	V
Logic supply	V_{DD}	-0.3	$V_{SS}+25$	V
Logic ground	V_{SS}	$V_{CC}-25$	$V_{SS}+0.3$	V
Logic input of HIN & LIN	V_{IN}	-0.3	$V_{CC}+0.3$	V
Allowable Offset Supply Voltage Transient	dV_S/dt		50	V/ns
HBM Model	ESD	1500		V
Machine Model		500		V
Package Power Dissipation @ $T_A \leq 25^\circ C$	P_D		625	mW
Thermal Resistance., Junction to Ambient	R_{thJA}		200	W/°C
Junction Temperature	T_J		150	°C
Storage Temperature	T_S	-55	150	°C
Lead Temperature (Soldering, 10 seconds)	T_L		300	°C



7. Recommended Operating Conditions

For proper operation, the device should be used under the following recommended conditions. The bias ratings of VS and VSS are measured at a supply voltage of 15V, and unless otherwise specified, the ratings of all voltage parameters are referenced to VSS and the ambient temperature is 25°C.

Parameter	Symbol	Min	Max	Units
High side floating supply	V _B	V _S +10	V _S +20	V
High side floating supply return	V _S	-9	600	V
High side gate drive output	V _{HO}	V _S	V _B	V
Low side and main power supply	V _{CC}	10	20	V
Low side gate drive output	V _{LO}	0	VCC	V
Logic supply	V _{DD}	V _{SS} +3	V _{SS} +20	V
Logic ground	V _{SS}	-5	5	V
Logic input of HIN & LIN	V _{IN}	0	VCC	V
Ambient temperature	T _A	-40	125	°C

Note1: Transient negative VS can be used for VSS-50V with a pulse width of 50ns, guaranteed by design.

Note2: When the input pulse width is less than 1us, the input pulse cannot be transmitted normally .



8. Electrical Characteristic

Valid for temperature range at $T_A=25^\circ\text{C}$, $V_{DD}=V_{CC}=V_B=15\text{V}$, $C_L=1\text{nF}$, unless otherwise specified.

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Turn-on propagation delay	t_{ON}	$V_S=0\text{V}$		130	200	ns
Turn-off propagation delay	t_{OFF}	$V_S=700\text{V}$		130	200	ns
Shutdown propagation delay	t_{sd}	$V_S=700\text{V}$		130	200	ns
Turn-on rise time	t_R			25	35	ns
Turn-off fall time	t_F			17	25	ns
Matched propagation time delay	MT				10	ns
V_{CC} supply UVLO threshold	V_{CCUV+}		8	8.9	9.8	V
	V_{CCUV-}		7.4	8.2	9	V
hysteresis of V_{CC} UVLO	$V_{CCUVHYS}$			0.7		V
V_{BS} supply UVLO threshold	V_{BSUV+}		8	8.9	9.8	V
	V_{BSUV-}		7.4	8.2	9	V
hysteresis of V_{BS} UVLO	$V_{BSUVHYS}$			0.7		V
High-side floating supply leakage current	I_{LK}	$V_B=V_S=700\text{V}$			50	μA
Quiescent V_B supply current	I_{QBS}	$V_{IN}=0\text{V}$ or V_{DD}		70	120	μA
Quiescent V_{CC} supply current	I_{QCC}	$V_{IN}=0\text{V}$ or V_{DD}		120	240	μA
Quiescent V_{DD} supply current	I_{QDD}	$V_{IN}=0\text{V}$ or V_{DD}		15	30	μA
Logic "1"(HIN&LIN) input voltage	V_{IH}	$V_{CC}=10\text{V}$ to 20V	9.5			V
Logic "0"(HIN&LIN) input voltage	V_{IL}	$V_{CC}=10\text{V}$ to 20V			6	V
High level output voltage, VBIAS -VO	V_{OH}	$I_o=0\text{A}$			1.4	V
Low level output voltage, VO	V_{OL}	$I_o=0\text{A}$			0.1	V
Logic "1" Input bias current	I_{IN+}	$V_{IN}=V_{DD}$		20	40	μA
Logic "0" input bias current	I_{IN-}	$V_{IN}=0\text{V}$			2	μA
Output high short circuit pulsed current	I_{O+}	$V_o=0\text{V}$, $V_{IN}=V_{DD}$, $PW \leq 10\text{us}$	3	4		A
Output low short circuit pulsed current	I_{O-}	$V_o=15\text{V}$, $V_{IN}=V_{DD}$, $PW \leq 10\text{us}$	3	4		A

9. Function Description

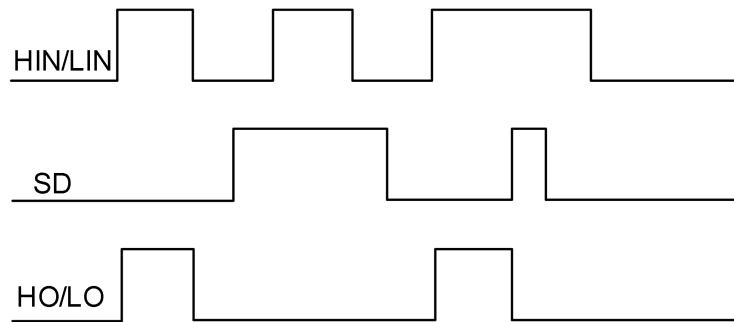


Figure 8-1 IR2110STR Input and output timing waveform

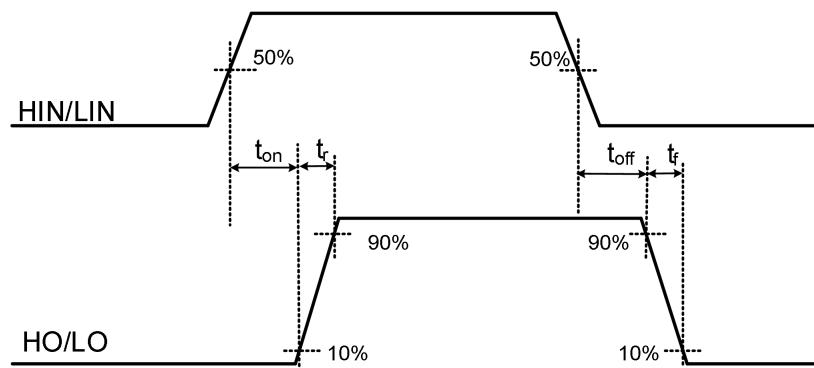


Figure 8-2 Propagation Time Waveform Definition

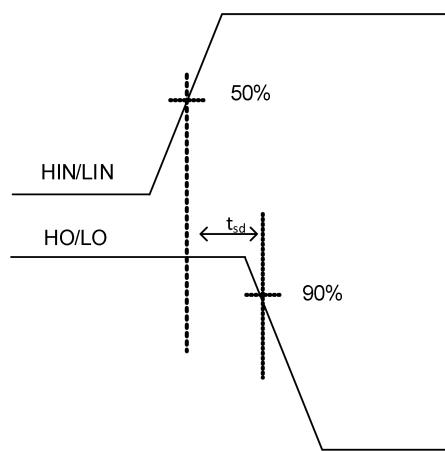


Figure 8-3 Shutdown Propagation Time Waveform Definition

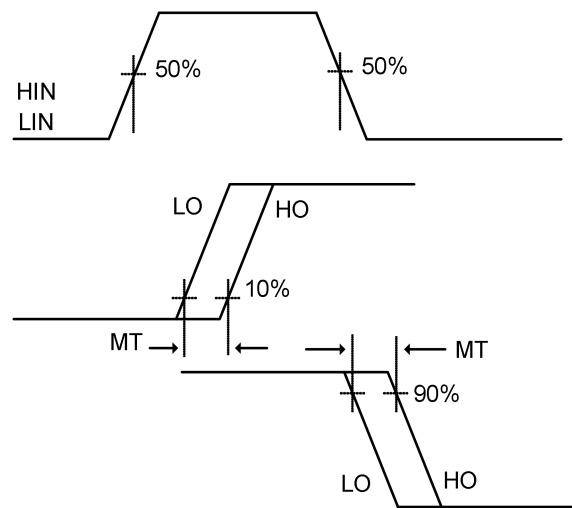


Figure 8-4 Matched propagation time delay Waveform Definition

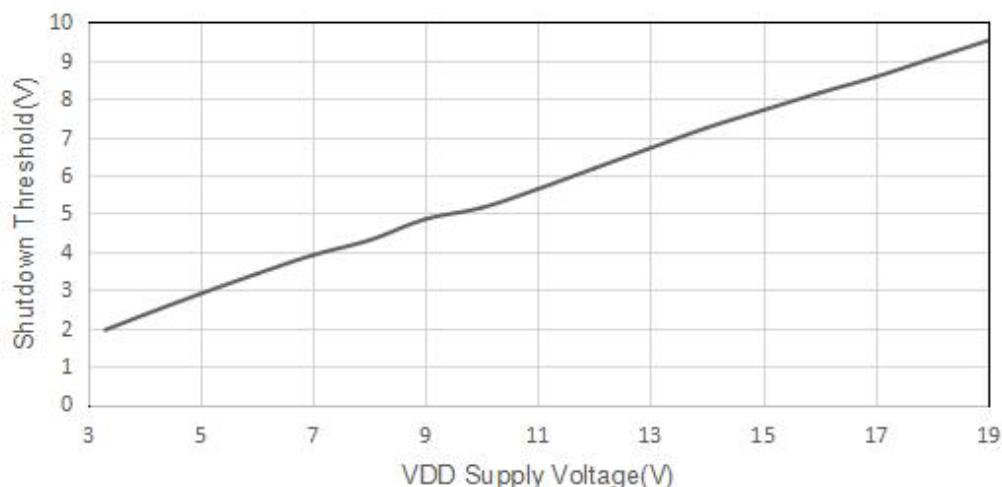


Figure 8-5 Mapping between input threshold voltage and VDD voltage (Typical)

10. Function Block Diagram

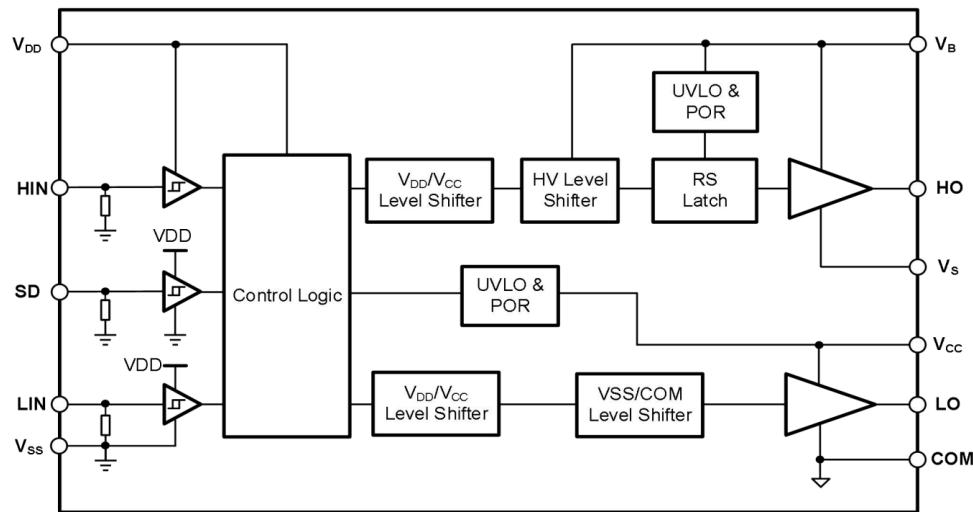


Figure9-1 Function Block Diagram of UMW IR2110STR

11. Application message

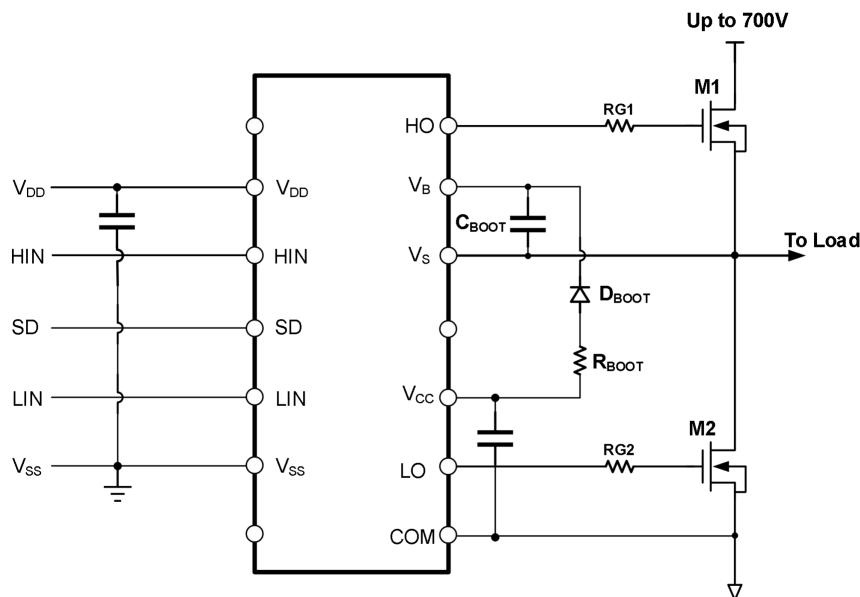
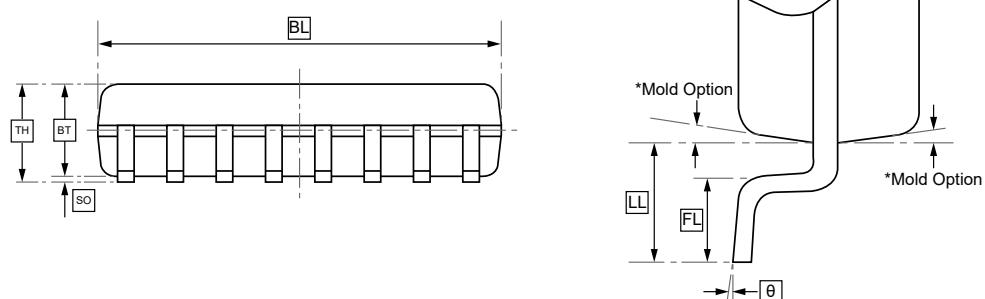
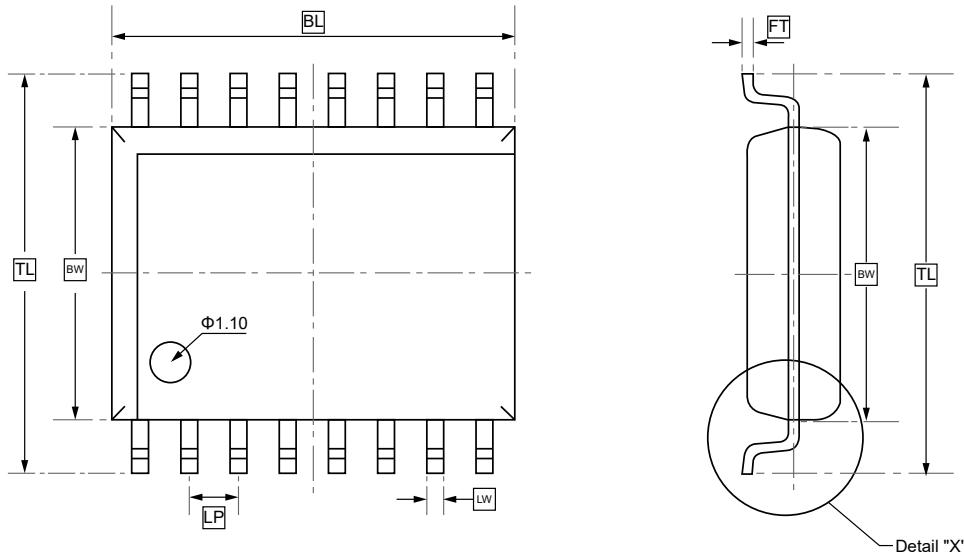


Figure9-2 Typical application circuit of UMW IR2110STR



12. SOP-16-300mil Package Outline Dimensions

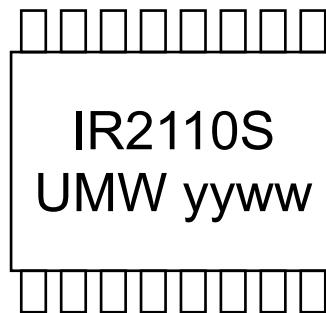


DIMENSIONS (mm are the original dimensions)

Symbol	BL	BW	TL	LW	LP	FT	BT	SO	TH	LL	FL	θ
Min	10.20	7.30	10.10	0.400	1.270	0.170	2.24	0.100	2.590	1.30	0.60	0°
Max	10.45	7.70	10.50	TYP	TYP	0.300	2.44	0.250	Max.	1.50	1.00	8°



13.Ordering information



yy: Year Code

ww: Week Code

Order Code	Package	Base QTY	Delivery Mode
UMW IR2110STR	SOP-16-300mil	2500	Tape and reel



14.Disclaimer

UMW reserves the right to make changes to all products, specifications. Customers should obtain the latest version of product documentation and verify the completeness and currency of the information before placing an order.

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